2025 International Symposium of Electronics Design Automation (ISEDA 2025)

Hong Kong, China
9-12 May 2025

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Table of Contents

Invited Papers

Chapter 1: System-Level Modeling and Design Methodology

Chapter 2: Memory Architecture and Near/In Memory Computing

Chapter 3: Analog-Mixed Signal Design Automation

Chapter 4: High-Level, Behavioral, and Logic Synthesis and Optimization

Chapter 5: Analysis and Optimization for Power and Timing

Chapter 6: Physical Implementation

Chapter 7: Testing, Validation, Simulation, and Verification

Chapter 8: Design for Manufacturability and Reliability

Chapter 9: Packaging & Multi-physics Simulation

Chapter 10: Technology & Modeling

Chapter 11: Emerging Technologies and Applications

Chapter 12: AI & Open Source EDA

Author Index